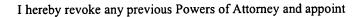
Docket No. 5181-59700 P4788

DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

	My residence, post office add	dress, and citizenship are a	s stated below next to m	y name.	
was filed on December 18, 2000 as Application Serial No. 09/740,542 and was amended on	joint inventor (if plural names are lis sought on the invention entitled "DIF	sted below) of the subject	matter which is claime	d and for whi	ich a patent is
I acknowledge the duty to disclose to the Patent and Trademark Office all information known to me material to patentability of the subject matter claimed in this application, as "materiality" is defined in 37 C.F. 1.56. I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any for application(s) for patent or inventor's certificate listed below, or under § 365(a) of any PCT international applicitate below designating least one country other than the United States of America, and have identified below foreign application for patent or inventor's certificate, or of any PCT international application, having a filing before that of the application on which priority is claimed. Prior Foreign Application No. Country Filing Date (mm/dd/yy) N/A I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below. Provisional Application No. Filing Date (mm/dd/yy) N/A I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below, or u § 365(c) of any PCT international application listed below designating the United States of America, and, insoft the subject matter of each of the claims of this application is not disclosed in the prior United States or international application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the dudisclose all information known to me to be material to the patentability of the subject matter claimed in application, as "materiality" is defined in 37 C.F.R. § 1.56, which became available between the filing date or prior application and the national or PCT international filing date of this application. Parent Application No. Filing Date (mm/dd/yy)	was filed on December 1				
I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any for application(s) for patent or inventor's certificate listed below, or under § 365(a) of any PCT international applic listed below designating least one country other than the United States of America, and have identified below foreign application for patent or inventor's certificate, or of any PCT international application to the application on which priority is claimed. Prior Foreign Application No. Country Filing Date (mm/dd/yy) I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below. Provisional Application No. Filing Date (mm/dd/yy) N/A I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below. Provisional Application No. Filing Date (mm/dd/yy) N/A I hereby claim the benefit under 35 U.S.C. § 120 of any United States of America, and, insoft the subject matter of each of the claims of this application is not disclosed in the prior United States or international application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the dudisclose all information known to me to be material to the patentability of the subject matter claimed in application, as "materiality" is defined in 37 C.F.R. § 1.56, which became available between the filing date of prior application and the national or PCT international filing date of this application. Parent Application No. Filing Date (mm/dd/yy) Parent Patent No. (if applicable) or Status				ove-identified	specification,
application(s) for patent or inventor's certificate listed below, or under § 365(a) of any PCT international applic listed below designating least one country other than the United States of America, and have identified below foreign application for patent or inventor's certificate, or of any PCT international application, having a filing before that of the application on which priority is claimed. Prior Foreign Application No. Country Filing Date (mm/dd/yy) Thereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) below. Provisional Application No. Filing Date (mm/dd/yy) N/A I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below, or u § 365(c) of any PCT international application listed below designating the United States of America, and, insoft the subject matter of each of the claims of this application is not disclosed in the prior United States or international application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the du disclose all information known to me to be material to the patentability of the subject matter claimed in application, as "materiality" is defined in 37 C.F.R. § 1.56, which became available between the filing date o prior application and the national or PCT international filing date of this application. Parent Application No. Filing Date (mm/dd/yy) Parent Patent No. (if applicable) or Status (mm/dd/yy)	material to patentability of the subjec				
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N/A	Parent Application No.		Parent Patent No. (if	applicable) or	Status
	N/A				



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each of said attorneys or agents being a member or an associate of the firm of Conley, Rose & Tayon, P.C., as attorney or agent for so long as they remain with such company or firm, with full power of substitution and revocation, to prosecute the application, to make alterations and amendments therein, to transact all business in the Patent and Trademark Office in connection therewith, and to receive the Letters Patent.

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Docket No. 5181-59700 P4788

I hereby declare that all statements made herein of my own knowledge are true and that all statements made herein on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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	(Include numbe	er, street name, city, state	and zip code)		

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